产品性能与规格承认书

物料名称: RFANT5220110A0T

样品颜色: ______蓝色__

样品种类: _____SMD 天线______

客户型号: ______

供应商: 金航标电子有限公司

拟制	结构	品质	批准	送样日期
李辉	刘文汇	贺俊驹	刘千红	

客户:

部门	确认	日期	状态	签字盖章
电子				
结构				
品质				
项目				

保密要求

深圳市金航标电子有限公司已拥有专有技术所提供的资料,未经深圳市金航标电子有限公司事先书面同意不允 许透露给任何人或公司。

FEATURES

- 1. Surface Mounted Devices with a small dimension of 5.2 x 2.0 x 1.1 mm³ meet future miniaturization trend.
- 2. Embedded and LTCC (Low Temperature Co-fired Ceramic) technology is able to future integrate with system design as well as beautifying the housing of final product.
- 3. High Stability in Temperature / Humidity Change

APPLICATIONS

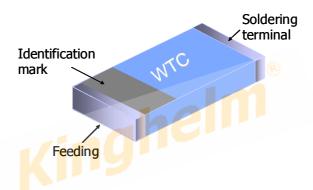
- 1. Bluetooth
- 2. Wireless LAN
- 3. HormRF
- 4. ISM band 2.4GHz wireless applications

DESCRIPTION

Walsin Technology Corporation develops a new ceramic embedded antenna specified for 2.4 GHz ISM Band application, as shown in below "CONSTRUCTION". Both of Wireless LAN IEEE 802.11b and Bluetooth TM typically located on this unlicensed frequency band which range covers from 2.4GHz to 2.4835GHz. To fulfil the friendly usage for antenna, this antenna has been designed to a typical 150MHz bandwidth through Walsin's advanced LTCC (Low Temperature Co-fired Ceramic) technology and superior product design via 3D EM Simulation Skill.

This antenna has a rectangular ceramic body with a tiny dimension of 5.2x 2.0 x 1.1 mm³ meet the future SMT automation and miniaturization requirements on modern portable devices.

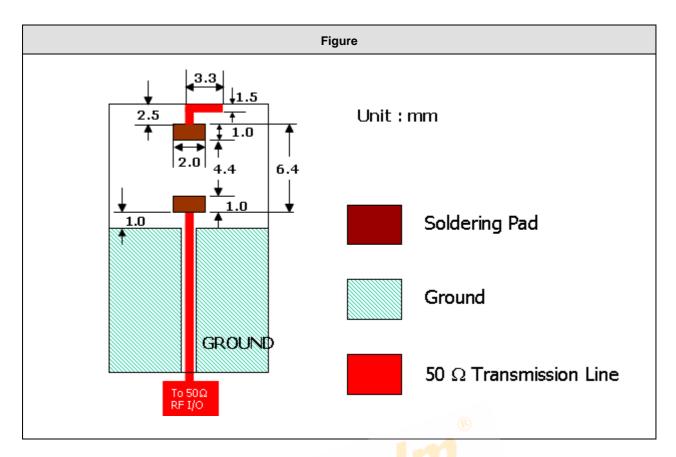
CONSTRUCTION



DIMENSIONS

Figure	Symbol	Dimension
L=2.0±0.2mm T=1.15±0.1mm	L	5.20 ± 0.20 mm
.0.25mm .25mm	W	2.00 ± 0.20 mm
W=5.2±0.2mm A=0.4±0.25mm A=0.4±0.25mm	Т	1.15 ± 0.10 mm
	А	0.40 ± 0.25 mm

SOLDER LAND PATTERN DESIGN

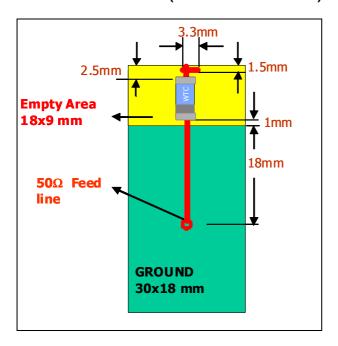


ELECTRICAL CHARACTERISTICS

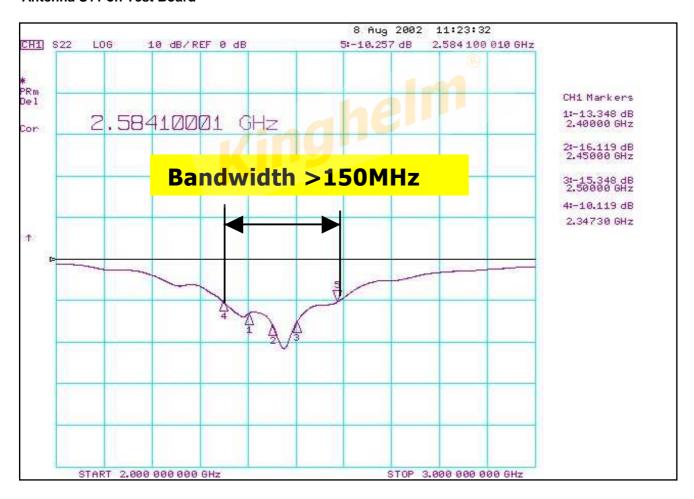
LECTRICAL CHARACTERISTICS				
RFANT5220110A0T	Specification			
Working Frequency Range	2.4 GHz ~ 2.5GHz			
Gain	2 dBi (Typical)			
VSWR	2 max.			
Polarization	Linear			
Azimuth Bandwidth	Omni-directional			
Impedance	50Ω			
Rated Power (max.)	3 Watts			
Maximum Input Power	5 Watts for 5 minutes			
Operation Temperature	-40°C ~ +85°C			

Remark: The specification is defined based on the test board dimension as in below

Antenna on Test Board (FR4 Thickness 0.8mm)

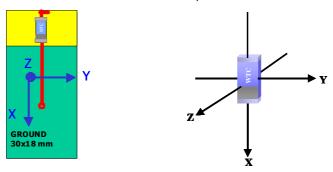


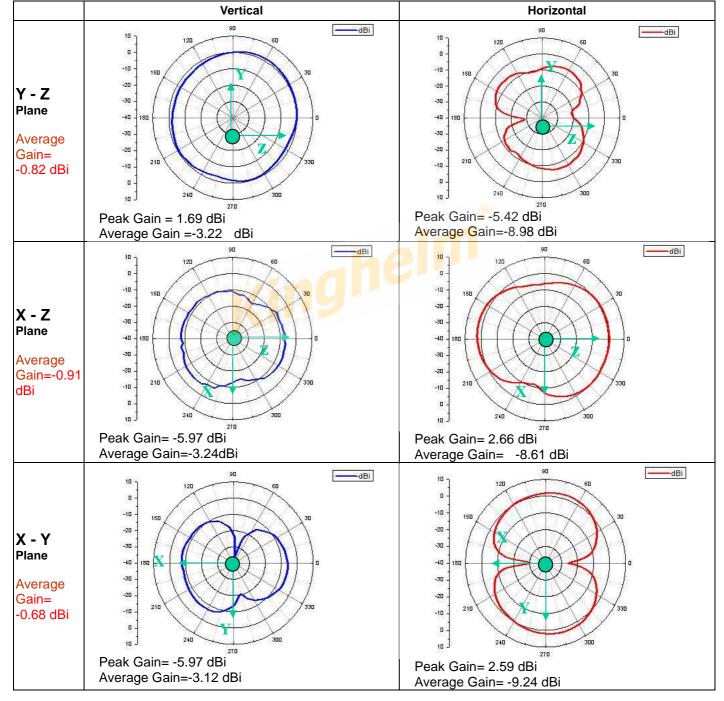
Antenna S11 on Test Board



RADIATION PATTERN

Radiation Pattern and Gain were dependent on measurement board design. The specification of RFANT5220110A0T antenna was measured based on the PCB size and installation position as shown in the below figure Test Board





RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature : $235 \pm 5^{\circ}$ C *Immersion time : 2 ± 0.5 sec *Solder : Sn3Ag0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature : $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time : $30 \pm 0.5 \text{ sec}$ *Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature: 120~150°C, 1 minute. *Solder temperature: 270±5°C *Immersion time: 10±1 sec *Solder: Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044	*Height: 75 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units; 2 times for each side.	after test.
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N(≤0603) ; 10N(>0603) *Test time : 10±1 sec	No remarkable damage or removal of the termination.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours	No mechanical damage. Samples shall satisfy electrical specification after test.

Temperature cycle	4 2012 minutes at 40001200	No machanical damage	
JIS C 0025	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.	
	2. 10~15 minutes at room temperature,	Samples shall satisfy electrical specification	
	3. 30±3 minutes at +85°C±3°C,	after test.	
	4. 10~15 minutes at room temperature,		
	Total 100 continuous cycles		
	Measurement to be made after keeping at		
	room temperature for 24±2 hrs		
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.	
JIS C 0040	*Total amplitude: 1.5mm	Samples shall satisfy electrical specification	
	*Test times : 6hrs.(Two hrs each in three	after test.	
	mutually perpendicular directions)		
High temperature			
JIS C 0021	*Temperature : 85°C±2°C	No mechanical damage.	
310 0 0021	*Test duration: 1000+24/-0 hours	Samples shall satisfy electrical specification	
	Measurement to be made after keeping at	after test.	
	room temperature for 24±2 hrs		
Humidity	*Humidity: 90% to 95% R.H.	No mechanical damage.	
(steady conditions)	*Temperature : 40±2°C	Samples shall satisfy electrical specification	
JIS C 0022	*Time: 1000+24/-0 hrs.	after test.	
	Measurement to be made after		
	keeping at room temperature for 24±2		
	hrs		
Low tomporature	1000hrs data		
Low temperature JIS C 0020	*Temperature : -40°C±2°C	No mechanical damage.	
313 0 0020	*Test duration: 1000+24/-0 hours	Samples shall satisfy electrical specification	
	Measurement to be made after keeping at	after test.	
	room temperature for 24±2 hrs		

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2

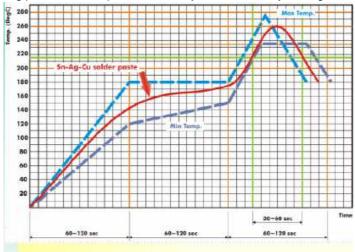


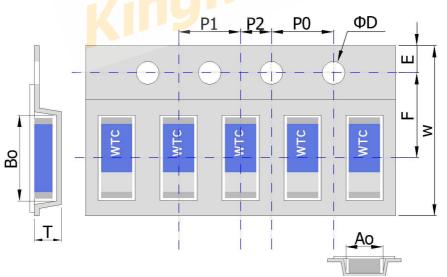
Fig 2. Infrared soldering profile

ORDERING CODE

RF	ANT	522011	0	Α	0	Т
Walsin	Product code	Dimension code	Unit of	Application	Specification	Packing
RF device	ANT : Antenna	Per 2 digits of	dimension	A: 2.4GHZ ISM	Design Code	T:7" Reeled
		Length, Width,	0 : 0.1 mm	Band		
		Thickness :	1 : 1.0 mm			
		e.g. :				
		522011 =				
		Length 52,		®		
		Width 20,		1-04		
		Thickness 11				

Minimum Ordering Quantity: 2000 pcs per reel.

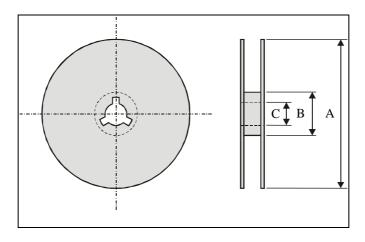
PACKAGING



Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	T	W
Dimension (mm)	2.40 ± 0.10	5.50 ± 0.10	1.55 ± 0.05	1.20 ± 0.10	12.0 ± 0.10
Index	Е	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	5.50 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10

Reel dimensions



Index	А	В	С
Dimension (mm)	Φ178	Φ60.0	Ф13.5

Typing Quantity: 2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : -10 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.